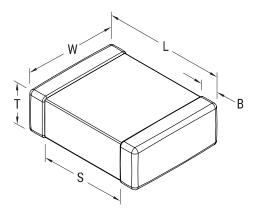
KEMET Part Number: C0603C153J3GECTU

(C0603C153J3GEC7867)



ESD SMD Comm C0G, Ceramic, 0.015 uF, 5%, 25 VDC, C0G, SMD, MLCC, Temperature Stable, Electro Static Discharge, Class I, 0603



Dimensions		
Chip Size	0603	
L	1.6mm +/-0.15mm	
W	0.8mm +/-0.15mm	
T	0.8mm +/-0.07mm	
S	0.7mm MIN	
В	0.35mm +/-0.15mm	

Packaging Specifications		
Packaging:	T&R, 180mm, Paper Tape	
Packaging Quantity:	4000	

General Information		
Series:	ESD SMD Comm C0G	
Style:	SMD Chip	
Description:	SMD, MLCC, Temperature Stable, Electro Static Discharge, Class I	
Features:	Temperature Stable, Low ESR, Class I	
RoHS:	Yes	
Termination:	Tin	
Marking:	No	
AEC-Q200:	No	
Component Weight:	3700 ug	
Shelf Life:	78 Weeks	
MSL:	1	

Specifications		
Capacitance:	0.015 uF	
Measurement Condition:	1 kHz 1.0Vrms	
Capacitance Tolerance:	5%	
Voltage DC:	25 VDC	
ESD Level per AEC-Q200:	25,000 V ESD Level	
Dielectric Withstanding Voltage:	62.5 VDC	
Temperature Range:	-55/+125°C	
Temperature Coefficient:	COG	
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC):	30 ppm/C, 1kHz 1.0Vrms	
Dissipation Factor:	0.1% 1 kHz 1.0Vrms	
Aging Rate:	0% Loss/Decade Hour	
Insulation Resistance:	66.6667 GOhms	

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